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# Performance Evaluation of DNA-based Self-Assembled Computers

A thesis submitted as a partial fulfillment of the requirements for the degree of Master of Science in Computer and Information Sciences.

By

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### **Abstract**

Silicon-based technology has in no doubt played the pivotal role in our civilization. Our lives have dramatically changed in every way, our productivity has increased, and our quality of life has advanced beyond imagination, and this all was majorly due to the discovery of semiconductors. Decades have passed, and we now have at our disposal advanced electronics as a product of a very mature technology. The advances in hardware capabilities have been taking steady steps for years, and our fabrication techniques have matured into stable low-error processes.

However, the natural evolution of technology is inevitable, and this is what the silicon based technology will face sooner or later. Moore's law has been accurately applied steadily since its inception, but the core of the law cannot be indefintely applicable. Although transistor sizes have decreased dramatically since their invention, with the 50% decrease rate Moore postulated, transistors are now approaching atomic level. The unavailabilty of fabrication technology at this scale, the instability at this resolution, and the increased error rate led to the conclusion that we need a replacement for silicon-based technology soon.

Various technologies have been proposed to replace siliconbased semiconductors. Carbon nanotubes are among the more prominent replacements due to their advantages in speed, power and size. The challenge is how to assemble carbon nanotubes to form a circuit. Our current top-down approach used in photolithography is not capable of assembling devices with that small size, and thus an alternative approach to the whole fabrication methodology was researched

Self-assembly relies on the bottom-up contruction of the circuit, without the interference of assembling equipment. The concept is similar to how biological cells assemble autonomously to form a complex organ. Yet in the nanoscale DNA was used to assemble carbon nanotubes; an autonomous process without our interference.

By leveraging the unique structure of DNA and it's ability to form shapes through controlling the sequences of a DNA strand, a lattice was built autonomously using DNA. The lattice will act as the scaffold on which the carbon nanotubes are assembled to form a circuit.

This thesis presents a novel parallel architecture to perform realtime median filtering of a stream of images. The architecture is then put through the design flow of DNA-based self-assembled circuits to produce the final output, consisting of a set of DNA sequences and their assembly order. The carbon nanotube based circuit is simulated to produce power and timing results and these results are compared to the CMOS implementation of the architecture. The advantages of using carbon nanotubes in both power and delay are demonstrated. The tools developed to aid in the design of self assembled circuits are presented.

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